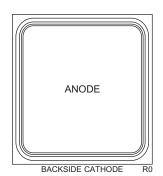


# CPD81R-CZSH5-40

# Schottky Rectifier Die 5.0 Amp, 40 Volt

The CPD81R-CZSH5-40 is a silicon Schottky rectifier ideal for all types of commercial, industrial, entertainment, and computer applications.



## **MECHANICAL SPECIFICATIONS:**

Die Size	72.4 x 72.4 MILS
Die Thickness	3.9 MILS
Anode Bonding Pad Size	64 x 64 MILS
Top Side Metalization	AI – 30,000Å
Back Side Metalization	Au – 9,000Å
Scribe Alley Width	2.36 MILS
Wafer Diameter	5 INCHES
Gross Die Per Wafer	3,137

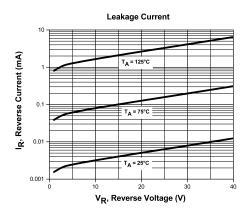
MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	$V_{RRM}$	40	V
DC Blocking Voltage	$V_{R}$	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Forward Current (T <sub>A</sub> =75°C)	Ìο	5.0	Α
Peak Forward Surge Current, tp=8.3ms	I <sub>FSM</sub>	125	Α
Operating and Storage Junction Temperature	$T_J$ , $T_{stg}$	-65 to +150	°C
ELECTRICAL CHARACTERISTICS: (T <sub>A</sub> =25°C) SYMBOL TEST CONDITIONS I <sub>R</sub> V <sub>R</sub> =40V	MIN	<b>MAX</b> 3.0	UNITS mA
V <sub>F</sub>		0.55	V
$C_J$ $V_R=0$ , $f=1.0MHz$		1500	pF

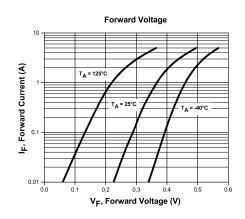
# CPD81R-CZSH5-40

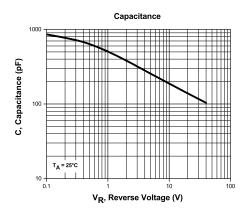
# **Typical Electrical Characteristics**

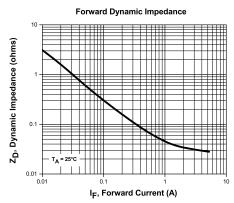


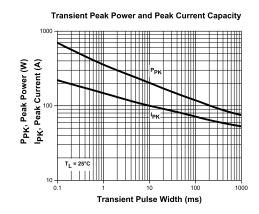
www.centralsemi.com

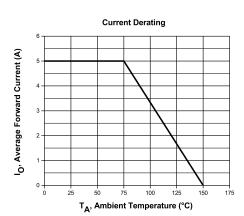








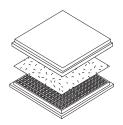




R1 (15-September 2016)

## BARE DIE PACKING OPTIONS

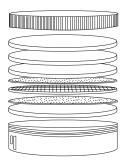




# BARE DIE IN TRAY (WAFFLE) PACK

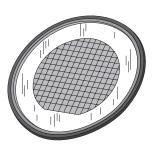
CT: Singulated die in tray (waffle) pack.
(example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-PART NUMBER-CM)



## **UNSAWN WAFER**

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



#### SAWN WAFER ON PLASTIC RING

**WR**: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked.

(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

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